

#### **Features**

- UL recognition, file #E230084
- Glass passivated chip junction
- Ideal for printed circuit boards
- High surge current capability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

#### **Typical Applications**

General purpose use in AC/DC bridge full wave rectification for monitor, TV, printer, power supply, switching mode power supply, adapter, audio equipment, and home appliances applications.

#### **Mechanical Data**

• Package: GBU

Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant

• Terminals: Tin plated leads, solderable per

J-STD-002 and JESD22-B102
• Polarity: As marked on body

#### ■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	GBU1016	
Device marking code			GBU1016	
Maximum Repetitive Peak Reverse Voltage	VRRM	٧	1600	
Maximum RMS Voltage	VRMS	٧	1120	
Maximum DC blocking Voltage	VDC	٧	1600	
Average rectified output current @60Hz sine wave, R- load  With heatsin Tc =110°C Without heat Ta =25°C	lo lo	А	10.0 2.5	
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave,1 cycle, Tj=25°C	IFSM	А	150	
Current squared time @1ms≤t≤8.3ms Tj=25°C, Rating of per diode	l <sup>2</sup> t	A <sup>2</sup> S	94	
Storage temperature	T <sub>stg</sub>	°C	-55 ~ <b>+</b> 150	
Junction temperature	Tj	°C	-55 ~ +150	
Dielectric strength @ Terminals to case, AC 1 minute	Vdis	KV	2.5	
Mounting torque @Recommend torque: 5kg·cm	Tor	kg-cm	8	



# **GBU1016**

**■Electrical Characteristics** (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	GBU1016
Maximum instantaneous forward voltage drop per diode	VF	>	IFM=5.0A	1.05
Maximum DC reverse current at rated DC blocking voltage			T <sub>j</sub> =25°C	5
per diode	ıĸ .	μΑ	T <sub>j</sub> =125°C	500
Typical junction capacitance	Cj	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	32

### **■Thermal Characteristics** (T<sub>a</sub>=25°C Unless otherwise specified)

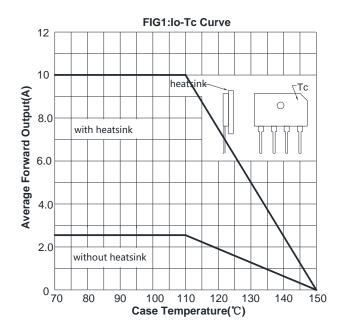
	PARAMETER	SYMBOL	UNIT	GBU1016
Thermal	Between junction and ambient, Without heatsink	RθJ-A	°C/W	25.0
Resistance	Between junction and case, With heatsink	R <sub>0</sub> J-C		2.0

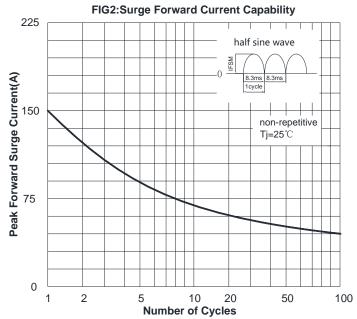
Note: Device mounted on 75mm x 45mm x 5.5mm Aluminum Plate Heatsink.

**■Ordering Information** (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
GBU1016	B1	Approximate 3.97	20	1000	2000	TUBE

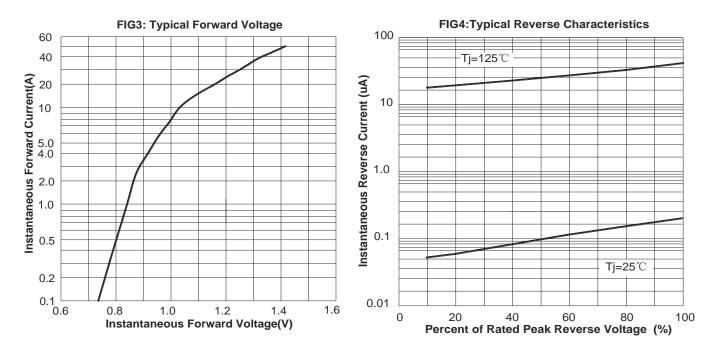
### **■ Characteristics** (Typical)



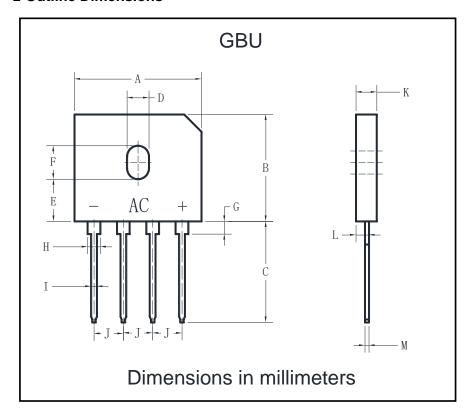








#### **■ Outline Dimensions**



GBU					
Dim	Min	Max			
Α	21.80	22.30			
В	18.30	18.80			
С	17.50	18.00			
D	3.30	3.90			
Е	7.10	7.50			
F	5.50	5.90			
G	1.91	2.54			
Н	2.06	2.54			
ļ	1.02	1.27			
J	4.83	5.33			
K	3.30	3.56			
L	2.40	2.66			
M	0.46	0.56			



## **GBU1016**

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